

60V P-Channel MOSFETs

General Description

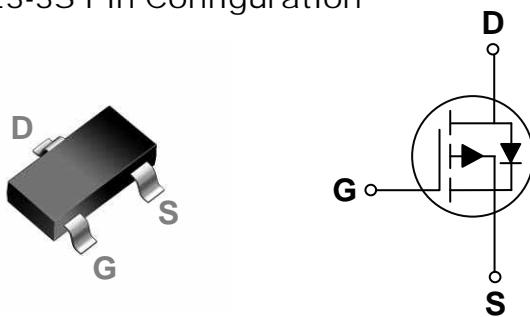
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

| BVDSS | RDS(ON) | ID |
|-------|---------|-----|
| -60V | 190mΩ | -2A |

Features

- -60V,-2A, RDS(ON) =190mΩ @ VGS = -10V
- Improved dv/dt capability
- Fast switching
- Green Device Available

SOT23-3S Pin Configuration



Applications

- Motor Drive
- Power Tools
- LED Lighting

Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|-----------|--|------------|-------|
| V_{DS} | Drain-Source Voltage | -60 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| I_D | Drain Current – Continuous ($T_c=25^\circ\text{C}$) | -2 | A |
| I_D | Drain Current – Continuous ($T_c=100^\circ\text{C}$) | -1.25 | A |
| I_{DM} | Drain Current – Pulsed ¹ | -8 | A |
| P_D | Power Dissipation ($T_c=25^\circ\text{C}$) | 1.56 | W |
| P_D | Power Dissipation – Derate above 25°C | 0.012 | W/°C |
| T_{STG} | Storage Temperature Range | -50 to 150 | °C |
| T_J | Operating Junction Temperature Range | -50 to 150 | °C |

Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--|------|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction to ambient | --- | 80 | °C/W |

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Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Off Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--|--|---|------|-------|-----------|---------------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$ | -60 | --- | --- | V |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $I_D=-1\text{mA}$ | --- | -0.05 | --- | $\text{V}/^\circ\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $V_{\text{DS}}=-60\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$ | --- | --- | -1 | μA |
| | | $V_{\text{DS}}=-48\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=125^\circ\text{C}$ | --- | --- | -10 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$ | --- | --- | ± 100 | nA |

On Characteristics

| | | | | | | |
|---------------------|-----------------------------------|--|------|------|------|----------------------------|
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance | $V_{\text{GS}}=-10\text{V}$, $I_D=-2\text{A}$ | --- | 160 | 190 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=-4.5\text{V}$, $I_D=-1.5\text{A}$ | --- | 200 | 240 | $\text{m}\Omega$ |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$ | -1.2 | -1.9 | -2.5 | V |
| | | | --- | 5 | --- | $\text{mV}/^\circ\text{C}$ |
| g_{fs} | Forward Transconductance | $V_{\text{DS}}=-10\text{V}$, $I_D=-2\text{A}$ | --- | 3.5 | --- | S |

Dynamic and switching Characteristics

| | | | | | | |
|---------------------|------------------------------------|--|-----|------|-----|----|
| Q_g | Total Gate Charge ^{2,3} | $V_{\text{DS}}=-30\text{V}$, $V_{\text{GS}}=-10\text{V}$, $I_D=-2\text{A}$ | --- | 8.2 | 12 | nC |
| Q_{gs} | Gate-Source Charge ^{2,3} | | --- | 1.8 | 3.6 | |
| Q_{gd} | Gate-Drain Charge ^{2,3} | | --- | 1.5 | 3 | |
| $T_{\text{d(on)}}$ | Turn-On Delay Time ^{2,3} | $V_{\text{DD}}=-30\text{V}$, $V_{\text{GS}}=-10\text{V}$, $R_G=6\Omega$ | --- | 5.2 | 10 | ns |
| T_r | Rise Time ^{2,3} | | --- | 19 | 36 | |
| $T_{\text{d(off)}}$ | Turn-Off Delay Time ^{2,3} | | --- | 35 | 67 | |
| T_f | Fall Time ^{2,3} | | --- | 10.6 | 20 | |
| C_{iss} | Input Capacitance | $V_{\text{DS}}=-30\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 425 | 615 | pF |
| C_{oss} | Output Capacitance | | --- | 35 | 50 | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 20 | 30 | |

Drain-Source Diode Characteristics and Maximum Ratings

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-----------------|---------------------------|---|------|------|------|------|
| I_s | Continuous Source Current | $V_G=V_D=0\text{V}$, Force Current | --- | --- | -2 | A |
| | | | --- | --- | -4 | A |
| V_{SD} | Diode Forward Voltage | $V_{\text{GS}}=0\text{V}$, $I_s=-1\text{A}$, $T_J=25^\circ\text{C}$ | --- | --- | -1 | V |

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
3. Essentially independent of operating temperature.

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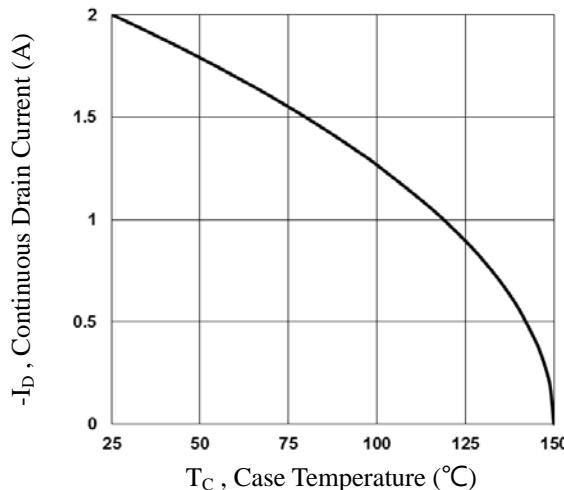


Fig.1 Continuous Drain Current vs. T_C

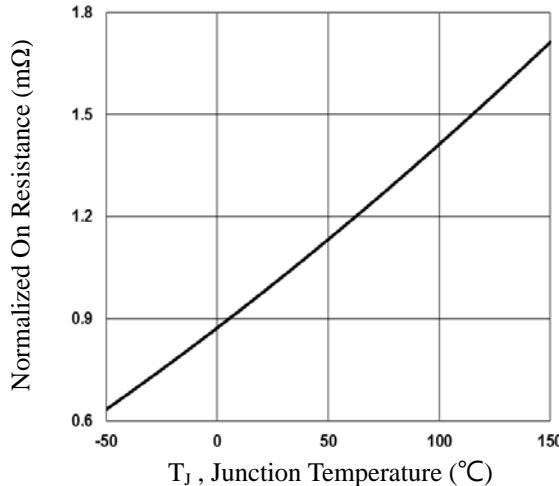


Fig.2 Normalized RDS(on) vs. T_J

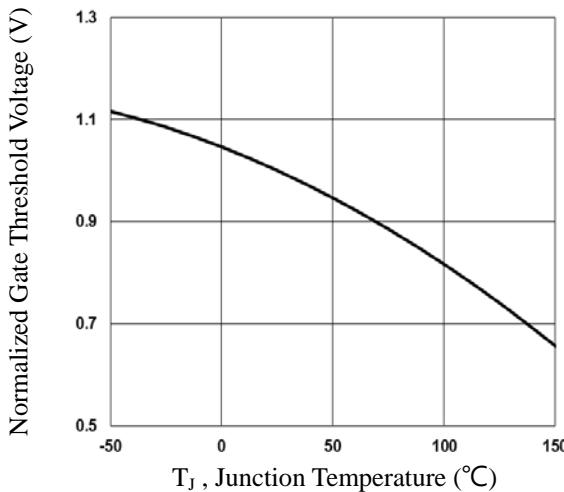


Fig.3 Normalized V_{th} vs. T_J

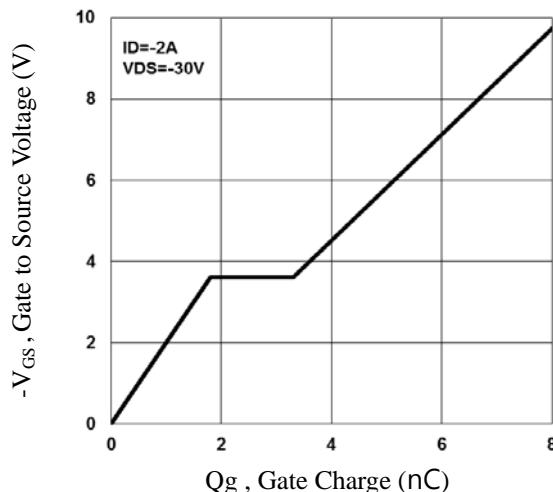


Fig.4 Gate Charge Waveform

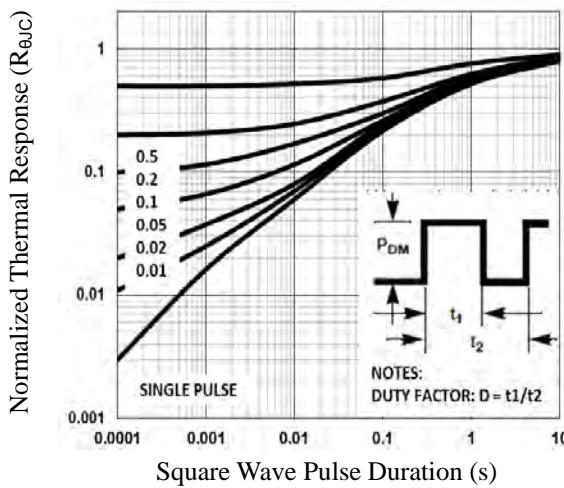


Fig.5 Normalized Transient Impedance

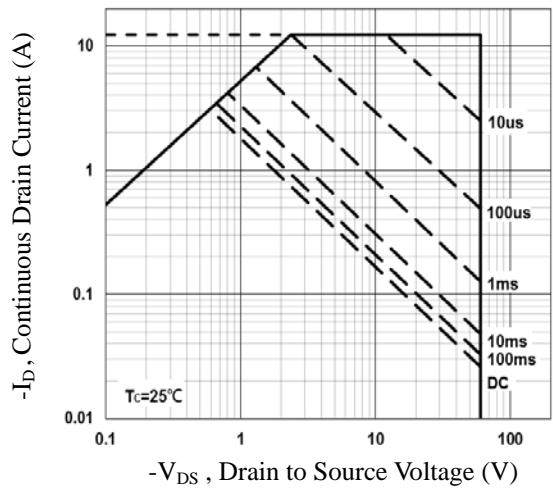


Fig.6 Maximum Safe Operation Area

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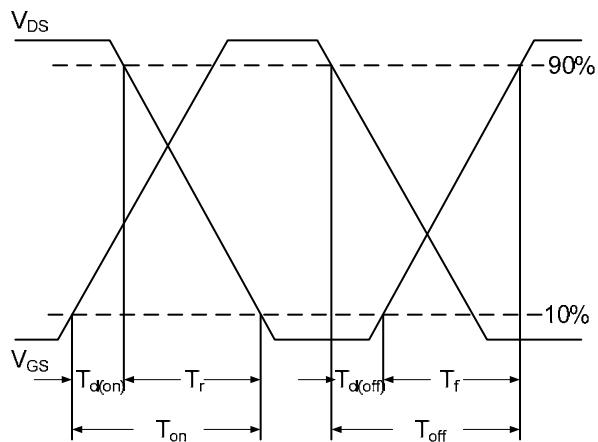


Fig.7 Switching Time Waveform

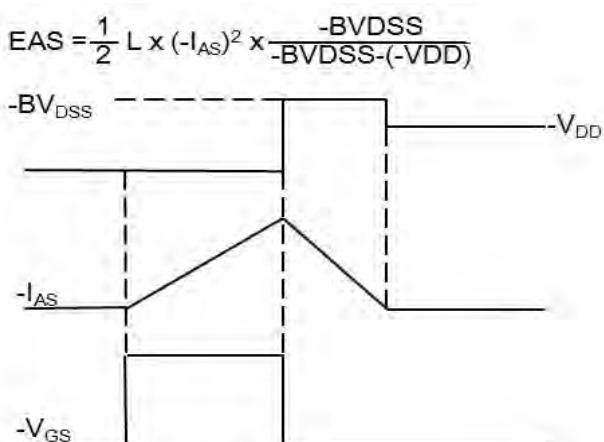
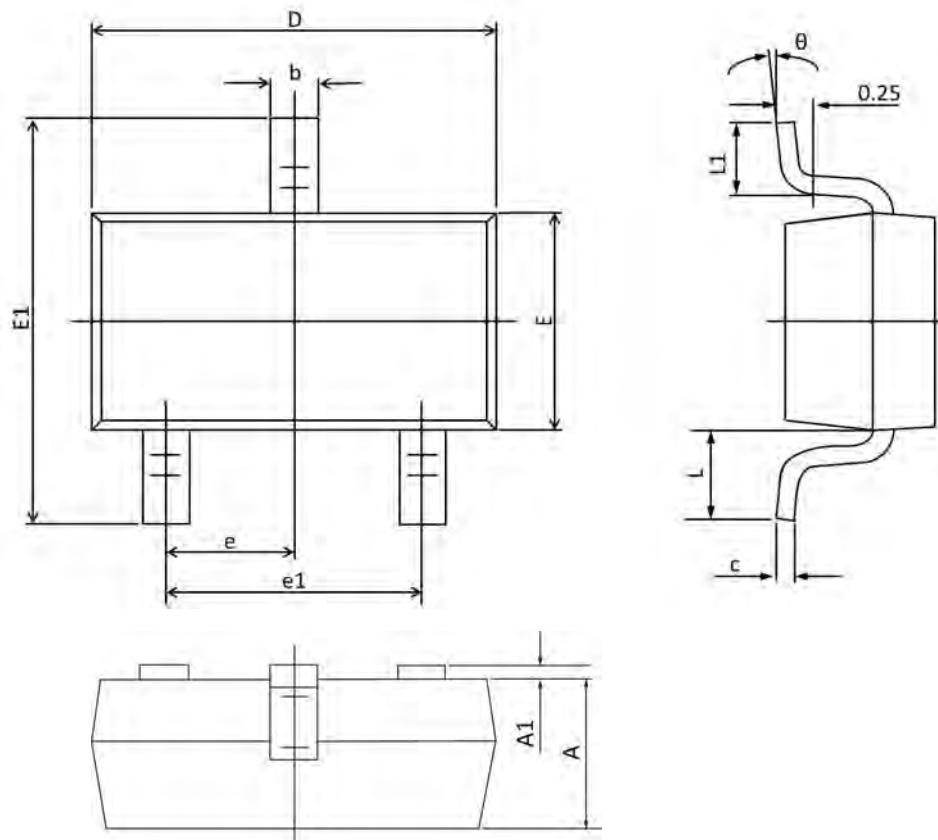


Fig.8 EAS Waveform

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SOT23-3S PACKAGE INFORMATION



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 0.900 | 1.000 | 0.035 | 0.039 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.090 | 0.110 | 0.003 | 0.004 |
| D | 2.800 | 3.000 | 0.110 | 0.118 |
| E | 1.200 | 1.400 | 0.047 | 0.055 |
| E1 | 2.250 | 2.550 | 0.089 | 0.100 |
| e | 0.950 TYP. | | 0.037 TYP. | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.550 REF. | | 0.022 REF. | |
| L1 | 0.300 | 0.500 | 0.012 | 0.020 |
| Θ | 1° | 7° | 1° | 7° |